



Click [here](#) for the 3D model.

| Dimensions | |
|------------|-----------------|
| D | 8mm +/-0.5mm |
| L | 10.2mm +/-0.3mm |
| W | 0.9mm +/-0.2mm |
| F | 0.3mm MAX |
| A | 8.3mm +/-0.2mm |
| B | 8.3mm +/-0.2mm |
| C | 10mm MAX |
| E | 3.4mm +/-0.2mm |
| G | 0.7mm +/-0.2mm |
| P | 3.1mm +/-0.2mm |

| Packaging Specifications | |
|--------------------------|-----|
| Packaging | T&R |
| Packaging Quantity | 500 |

| General Information | |
|---------------------|--------------------------------------|
| Series | EDT |
| Dielectric | Aluminum Electrolytic |
| Style | SMD Can |
| Description | Surface Mount, Aluminum Electrolytic |
| RoHS | Yes |
| Lead | V-Chip |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |

| Specifications | |
|-------------------------|------------------------|
| Capacitance | 100 uF |
| Capacitance Tolerance | 20% |
| Voltage DC | 35 VDC, 44 VDC (Surge) |
| Temperature Range | -40/+125°C |
| Rated Temperature | 125°C |
| Life | 2000 Hrs |
| Dissipation Factor | 14% |
| Ripple Current | 130 mAmps (120Hz 125C) |
| Leakage Current | 35 uA (2min 20°C) |
| Impedance Ratio at -25C | 2 |
| Impedance Ratio at -40C | 3 |
| High Temperature Solder | Yes |